Unit: mm

TOSHIBA Field Effect Transistor Silicon N Channel MOS Type $(\pi\text{-MOSV})$

2SK2543

Switching Regulator Applications

• Low drain-source ON resistance : RDS (ON) = 0.75Ω (typ.) • High forward transfer admittance : $|Y_{fs}| = 7.0 S$ (typ.) • Low leakage current : IDSS = $100 \mu A$ (max) (VDS = 500 V) • Enhancement mode : $V_{th} = 2.0 \sim 4.0 V$ (VDS = 10 V, ID = 1 mA)

Maximum Ratings (Ta = 25°C)

Characteris	stics	Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	500	V	
Drain-gate voltage (R _{GS} = 20 kΩ)		V _{DGR}	500	V	
Gate-source voltage		V _{GSS}	±30	V	
Drain current	DC (Note 1)	I _D	8	Α	
	Pulse (Note 1)	I_{DP}	32	Α	
Drain power dissipation	n (Tc = 25°C)	P_{D}	40	W	
Single pulse avalanche energy (Note 2)		E _{AS}	312	mJ	
Avalanche current		I _{AR}	8	А	
Repetitive avalanche e	energy (Note 3)	E _{AR}	4	mJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature ra	ange	T _{stg}	-55~150	°C	

1. GATE 2. DRAIN 3. SOURCE JEDEC JEITA SC-67 TOSHIBA 2.7±0.2

Weight: 1.9 g (typ.)

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th (ch-c)}	3.125	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	62.5	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: V_{DD} = 90 V, T_{ch} = 25°C (initial), L = 8.3 mH, R_G = 25 Ω , I_{AR} = 8 A

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device.

Please handle with caution.



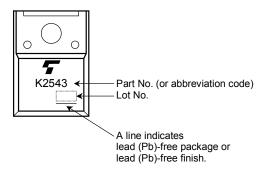
Electrical Characteristics (Ta = 25°C)

Charac	eteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	irrent	I _{GSS}	V _{GS} = ±25 V, V _{DS} = 0 V	_	_	±10	μΑ
Gate-source bre	eakdown voltage	V (BR) GSS	I _G = ±10 μA, V _{GS} = 0 V	±30	_	_	V
Drain cut-off cu	rrent	I _{DSS}	V _{DS} = 500 V, V _{DS} = 0 V	_	_	100	μA
Drain-source br	eakdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	500	_	_	V
Gate threshold v	voltage	V_{th}	V _{DS} = 10 V, I _D = 1 mA	2.0	_	4.0	V
Drain-source O	N resistance	R _{DS (ON)}	V _{GS} = 10 V, I _D = 4 A	_	0.75	0.85	Ω
Forward transfer	r admittance	Y _{fs}	V _{DS} = 10 V, I _D = 4 A	3.5	7.0	_	S
Input capacitano	e	C _{iss}			1300	_	
Reverse transfe	r capacitance	C _{rss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz		130	_	pF
Output capacitance		Coss]	_	400	_	
Switching time	Rise time	t _r	$V_{GS} \stackrel{10 \text{ V}}{\text{0 V}} \stackrel{\text{I}_{D} = 4 \text{ A}}{\text{0 V}} \stackrel{\text{Out}}{\text{0 U}} \stackrel{\text{RL}}{\text{0 V}} = 50 \Omega$ $V_{DD} \stackrel{\text{:}}{\text{:}} 200 \text{ V}$	_	26	_	
	Turn-on time	t _{on}		_	45	_	ne
	Fall time	t _f		ı	40	ı	- ns
	Turn-off time	t _{off}	Duty $\leq 1\%$, $t_{\rm w} = 10 \mu \rm s$	1	140	-	
Total gate charge (Gate-source plus gate-drain)		Qg	V _{DD} ≈ 400 V, V _{GS} = 10 V, I _D = 8 A		30	_	
Gate-source charge		Q_{gs}		_	17	_	nC
Gate-drain ("miller") charge		Q_{gd}			13		

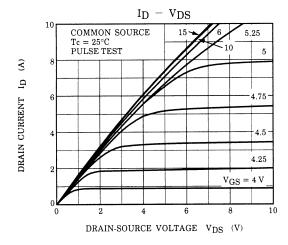
Source-Drain Ratings and Characteristics (Ta = 25°C)

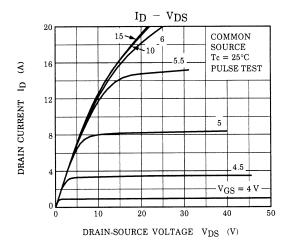
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	_	_	_	8	Α
Pulse drain reverse current (Note 1)	I _{DRP}	_	_	_	32	Α
Forward voltage (diode)	V _{DSF}	I _{DR} = 8 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	t _{rr}	I _{DR} = 8 A, V _{GS} = 0 V dI _{DR} / dt = 100 A / μs		1200		ns
Reverse recovery charge	Q _{rr}	dl _{DR} / dt = 100 A / μs	- 1	10	_	μC

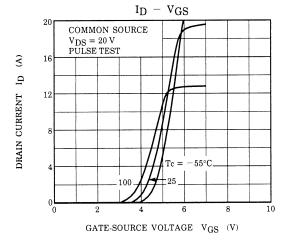
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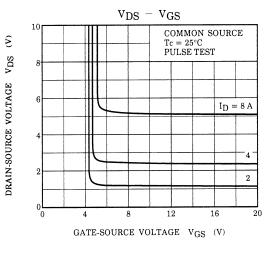


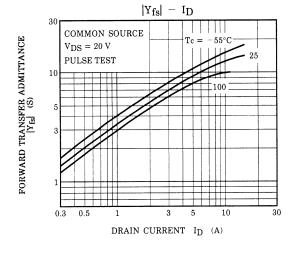
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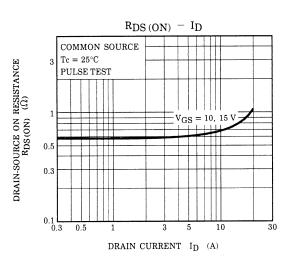


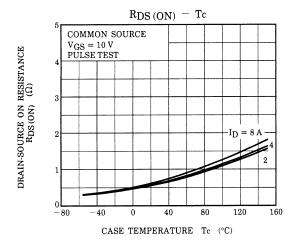


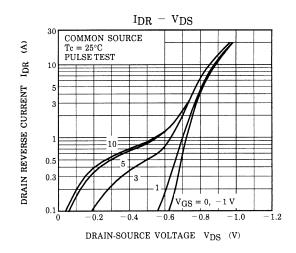


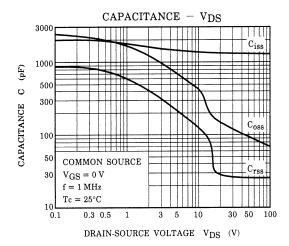


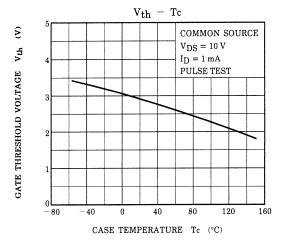


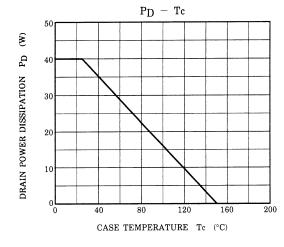


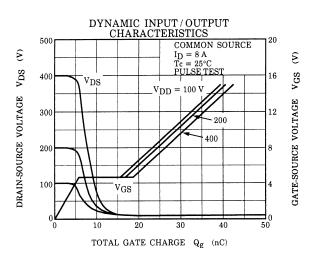




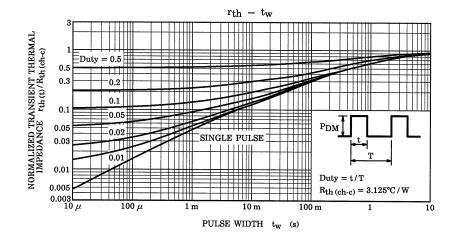


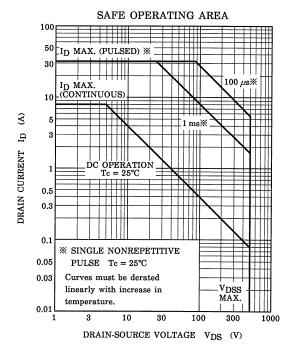


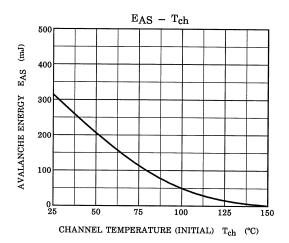


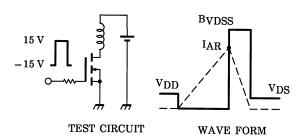


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$$\begin{aligned} &R_G = 25~\Omega \\ &V_{DD} = 90~V,~L = 8.3~mH \end{aligned} \qquad EAS = \frac{1}{2} \cdot L \cdot I^2 \cdot \left(\frac{BVDSS}{BVDSS - VDD}\right) \end{aligned}$$

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